



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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Serial No.:	09/810,846	Group Art Unit:	2841
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Title:	FIXTURE, CIRCUIT BOARD WITH FIXTURE, AND ELECTRONIC-COMPONENT MOUNTED BODY AND METHOD OF MANUFACTURING THE SAME		

Version With Markings to Show Changes Made

Please amend claims 1, 12, 20, 25 and 30 as follows:

- Claim 1. (Amended) A fixture, comprising:
- a base with an opening in its center portion;
- a movable pawl provided on the base for fixing an electronic component;
- and
- at least one pair of positioning walls for positioning the electronic component[.], wherein
- the at least one pair of positioning walls are inner wall faces of the base.
- Claim 12. (Amended) A circuit board with a fixture, comprising;
- a fixture mounted on a circuit board, for placing an electronic component;
- and
- electrodes formed on the circuit board with the fixture,
- wherein the fixture comprises a movable pawl for fixing an electronic component and at least one pair of positioning walls for positioning an electronic component, [and]
- the at least one pair of positioning walls are inner wall faces of the fixture.
- and

the electrodes are exposed between the at least one pair of positioning walls.

Claim 20. (Amended) An electronic-component mounted body, comprising:

a circuit board with electrodes;

a fixture; and

an electronic component with electrodes,

the electronic component being placed on a circuit board using the fixture, and

bumps formed on the electrodes of the electronic component or on the electrodes on the circuit board,

wherein the fixture comprises a movable pawl and at least one pair of positioning walls,

the movable pawl fixes the electronic component to the circuit board,

the at least one pair of positioning walls control a position of the electronic component in a direction parallel to a surface of the circuit board with the electronic component placed therebetween, and

the electrodes of the electronic component are connected to the electrodes on the circuit board formed between the at least one pair of positioning walls.

Claim 25. (Amended) The electronic-component mounted body according to claim 2[4]0, wherein the bumps and the electrodes on which the bumps are not formed are connected to each other with a conductive adhesive interposed therebetween.

Claim 30. (Amended) A method of manufacturing an electronic-component mounted body, comprising:

providing a circuit board provided with a fixture and electrodes, the fixture having a moveable pawl and at least one pair of positioning walls, wherein the at least one pair of positioning walls are inner wall faces of the fixture, [and]

the electrodes being formed to be exposed between the at least one pair of positioning walls; and

connecting electrodes of an electronic component and the electrodes on the circuit board by fitting the electronic component between the at least one pair of positioning walls and fixing the electronic component by the movable pawl.